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Docket No.: M4065.0374/P374
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Mike Brooks

Application No.: 09/760,741

Art Unit: 2815

Filed: January 17, 2001

Examiner: C. Chu

For: SEMICONDUCTOR ASSEMBLY
WITHOUT ADHESIVE FILLETS

10/21/03
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AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated July 16, 2003 (Paper No. 22), please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 9 of this paper.